DONGGUAN NANJING ELECTRONICS LTD.,

TO-247-2 Silicon Carbide Schottky Diode

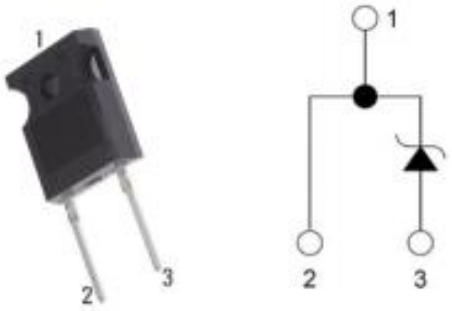
NJ30PS120A SiC Diode 1200V, 30A, 155nC

General Description

This product family offers state of the art performance. It is designed for high frequency applications here high efficiency and high reliability are required.

Features

- Zero Forward/Reverse Recovery Current
- High Blocking Voltage
- High Frequency Operation
- Positive Temperature Coefficient on VF
- Temperature Independent Switching Behavior
- High surge current capability



TO-247-2
Pin definition

Applications

- Motor Drives
- Solar / Wind Inverters
- AC/DC converters
- DC/DC converters
- Uninterruptable power supplies

Benefits

- Higher System Efficiency
- Parallel Device Convenience without thermal runaway
- Higher Temperature Application
- No Switching loss
- Hard Switching & Higher Reliability
- Environmental Protection

Key performance parameters

Type	V_R	I_F T_C=140℃	Q_C
NJ30PS120A	1200V	30A	155nC

Caution: This device is sensitive to electrostatic discharge .Users should follow ESD handing procedures.

Maximum Ratings

T_C=25℃, unless otherwise specified

Parameter	Symbol	Value	Unit
Peak Repetitive Reverse Voltage	V_{RRM}	1200	V

Maximum Ratings

T_C=25℃, unless otherwise specified

Parameter	Symbol	Value	Unit
Continuous Forward Current: T_C = 25°C T_C = 135°C T_C = 140°C	I_F	80 40 30	A
Non Repetitive Forward Surge Current： T_C = 25°C, tp =10ms, Half Sine Pulse T_C = 110°C, tp =10ms, Half Sine Pulse	I_{FSM}	230 220	A
Repetitive peak Forward Surge Current: Freq = 0.1Hz, 100 cycles T_C = 25°C, tp =10ms, Half Sine Pulse T_C = 110°C, tp =10ms, Half Sine Pulse	I_{FRM}	200 190	A
Total power dissipation ： T_C = 25°C T_C =110°C	P_D	330 140	W
Single Pulse Avalanche Energy：L = 2mH, IAS =15A	E_{As}	225	mJ
Diode dv/dt ruggedness：V_R = 0-1200V	dv/dt	80	V/ns
Operating Junction Temperature	T_j	-55 to 175	°C
Storage Temperature	T_{stg}	-55 to 175	°C

Thermal Resistance

Parameter	Symbol	Typ.	Max	Unit
Thermal resistance, junction-case	R_{thJC}	0.45	0.6	°C/W

Electrical Characteristic

T_C =25°C, unless otherwise specified

Parameter	Symbol	Value			Unit	Test Condition
		Min.	Typ.	Max.		
DC Blocking Voltage	V_{DC}	1200			V	T_j = 25°C
Forward Voltage	V_F		1.45 1.75 1.95	1.8	V	I_F = 30A T_j = 25°C T_J = 125°C T_j = 175°C
Reverse Current	I_R		15 60 100	200 300 500	uA	V_R = 1200V T_j = 25°C T_J = 125°C Tj =175°C
Total Capacitance Charge	Q_C		155		nC	V_R = 800V T_J = 25°C
Total Capacitance	C		1810 145 103		pF	V_R = 1V V_R = 400V V_R = 800V T_J = 25°C Freq = 1MHz

Typical Characteristics

Characteristics Curves

Figure 1. Forward Characteristics

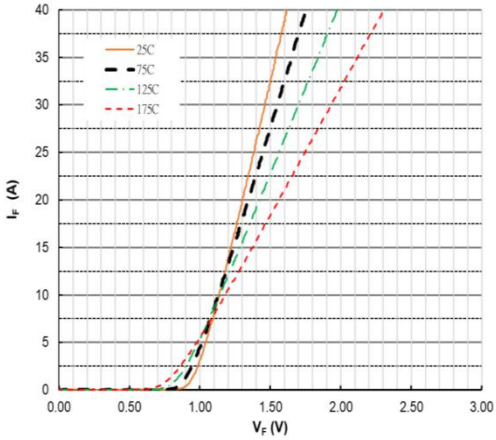


Figure 2. Forward Characteristics

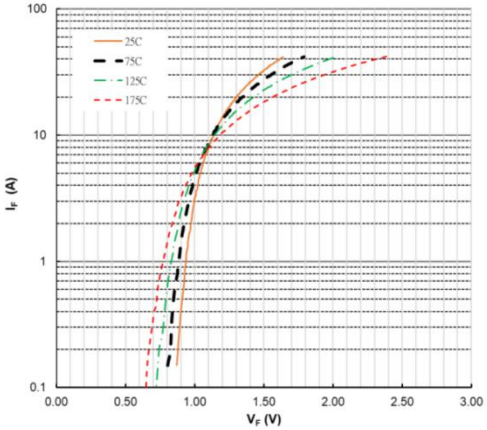


Figure 3. Reverse Characteristics

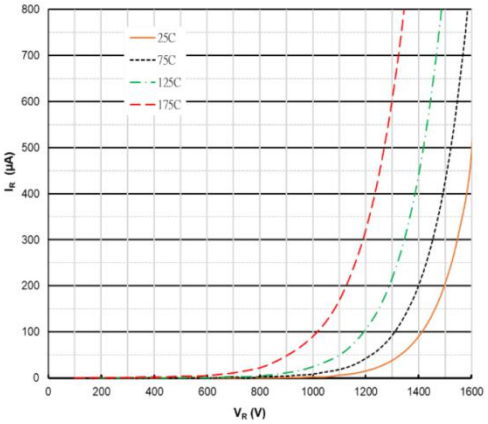


Figure 4. Power Derating

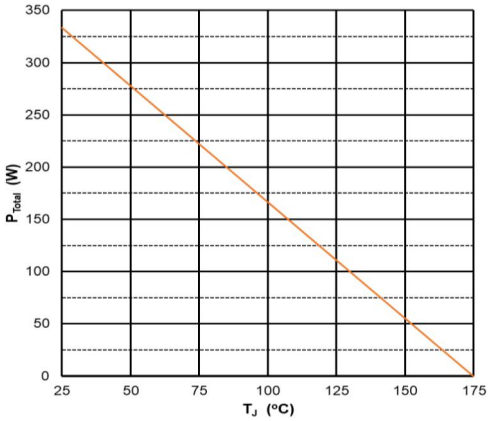


Figure 5. Capacitance vs Reverse Voltage

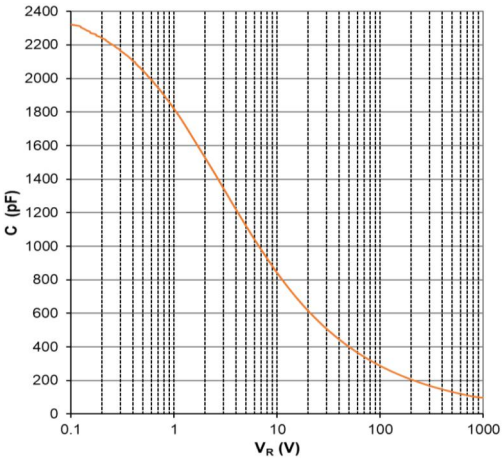
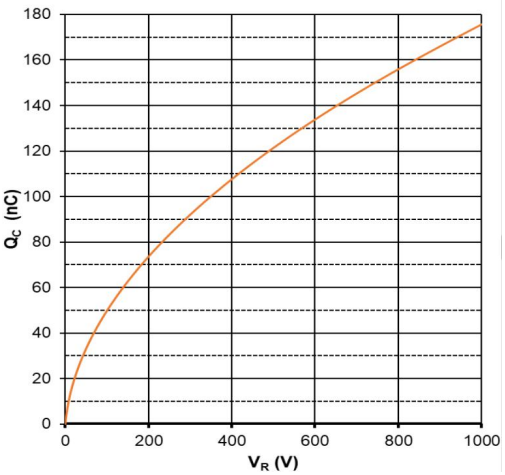
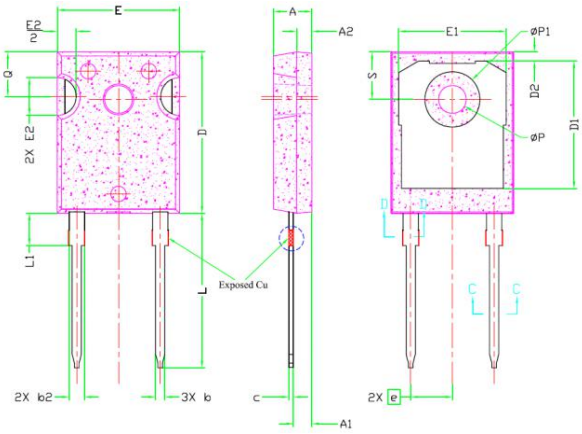


Figure 6. Recovery Charge vs Reverse Voltage

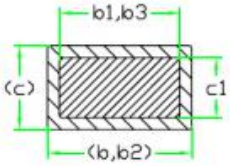


Package Outline:TO-247-2



SYMBOL	DIMENSIONS			NOTES
	MIN.	NOM.	MAX.	
A	4.83	5.02	5.21	
A1	2.29	2.41	2.55	
A2	1.50	2.00	2.49	
b	1.12	1.20	1.33	
b1	1.12	1.20	1.28	
b2	1.91	2.00	2.39	6
b3	1.91	2.00	2.34	
c	0.55	0.60	0.69	6
c1	0.55	0.60	0.65	
D	20.80	20.95	21.10	4
D1	16.25	16.55	17.65	5
D2	0.51	1.19	1.35	
E	15.75	15.94	16.13	4
E1	13.46	14.02	14.16	5
E2	4.32	4.91	5.49	3
e	5.44BSC			
L	19.81	20.07	20.32	
L1	4.10	4.19	4.40	6
ØP	3.56	3.61	3.65	7
ØP1	7.19REF.			
Q	5.39	5.79	6.20	
S	6.04	6.17	6.30	

Note:
1. Package Reference: JEDEC TO247, Variation AD.
2. All Dimensions Are In mm.
3. Slot Required, Notch May Be Rounded
4. Dimension D & E Do Not Include Mold Flash. Mold Flash Shall Not Exceed 0.127mm Pre Side. These Dimensions Are Measured At The Outermost Extreme Of The Plastic Body.
5. Thermal Pad Contour Optional Within Dimension D1 & E1.
6. Lead Finish Uncontrolled In L1.
7. ØP To Have A Maximum Draft Angle Of 1.5° To The Top Of The Part With A Maximum Hole Diameter Of 3.91mm.
8. Dimension "b2" And "b4" Does Not Include Dambar Protrusion. Allowable Dambar Protrusion Shall Be 0.10mm Total In Excess Of "b2" And "b4" Dimension At Maximum Material Condition.



Section C–C,D–D